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**NTE491  
NTE491SM  
MOSFET  
N-Ch, Enhancement Mode  
High Speed Switch**

**Features:**

- Available in either TO92 (NTE491) or SOT-23 Surface Mount (NTE491SM) Type Package
- High Density Cell Design for Low  $R_{DS(ON)}$
- Voltage Controlled Small Signal Switch
- Rugged and Reliable
- High Saturation Current capability

**Absolute Maximum Ratings:**

Drain–Source Voltage, $V_{DS}$ .....	60V
Drain–Gate Voltage ( $R_{GS} = 1M\Omega$ ), $V_{DGR}$ .....	60V
Gate–Source Voltage, $V_{GS}$	
Continuous .....	$\pm 20V$
Non-Repetitive ( $t_p \leq 50\mu s$ ) .....	$\pm 40V$
Drain Current, $I_D$	
Continuous	
NTE491 .....	200mA
NTE491SM .....	115mA
Pulsed	
NTE491 .....	500mA
NTE491SM .....	800mA
Total Device Dissipation ( $T_A = +25^\circ C$ ), $P_D$	
NTE491 .....	350mW
NTE491SM .....	200mW
Derate above $25^\circ C$	
NTE491 .....	$2.8mW/^\circ C$
NTE491SM .....	$1.6mW/^\circ C$
Operating Junction Temperature Range, $T_J$ .....	$-55^\circ$ to $+150^\circ C$
Storage Temperature Range, $T_{stg}$ .....	$-55^\circ$ to $+150^\circ C$
Thermal Resistance, Junction-to-Ambient, $R_{th}(JA)$	
NTE491 .....	$312.5^\circ C/W$
NTE491SM .....	$625^\circ C/W$
Maximum Lead Temperature (During Soldering, 1/16" from case, 10sec), $T_L$ .....	$+300^\circ C$

**Electrical Characteristics:** ( $T_A = +25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Test Conditions		Min	Typ	Max	Unit	
<b>OFF Characteristics</b>								
Drain–Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0, I_D = 10\mu\text{A}$		60	–	–	V	
Zero–Gate–Voltage Drain Current NTE491	$I_{\text{DSS}}$	$V_{DS} = 48\text{V}, V_{GS} = 0$	$T_J = +125^\circ\text{C}$	–	–	1.0	$\mu\text{A}$	
				–	–	1.0	mA	
		$V_{DS} = 60\text{V}, V_{GS} = 0$	$T_J = +125^\circ\text{C}$	–	–	1.0	$\mu\text{A}$	
				–	–	0.5	mA	
Gate–Body Leakage Current, Forward NTE491	$I_{GSSF}$	$V_{GSF} = 15\text{V}, V_{DS} = 0$		–	–	10	nA	
		$V_{GSF} = 20\text{V}, V_{DS} = 0$		–	–	100	nA	
Gate–Body Leakage Current, Reverse NTE491	$I_{GSSR}$	$V_{GSF} = -15\text{V}, V_{DS} = 0$		–	–	-10	nA	
		$V_{GSF} = -20\text{V}, V_{DS} = 0$		–	–	-100	nA	
<b>ON Characteristics</b> (Note 1)								
Gate Threshold Voltage NTE491	$V_{GS(\text{Th})}$	$I_D = 1\text{mA}, V_{DS} = V_{GS}$		0.8	–	3.0	V	
		$I_D = 250\mu\text{A}, V_{DS} = V_{GS}$		1.0	2.1	2.5	V	
Static Drain–Source ON Resistance NTE491	$r_{DS(\text{on})}$	$V_{GS} = 10\text{V}, I_D = 500\text{mA}$	$T_J = +125^\circ\text{C}$	–	1.2	5.0	$\Omega$	
				–	1.9	9.0	$\Omega$	
		$V_{GS} = 4.5\text{V}, I_D = 75\text{mA}$		–	1.8	5.3	$\Omega$	
		$V_{GS} = 10\text{V}, I_D = 500\text{mA}$	$T_J = +100^\circ\text{C}$	–	1.2	7.5	$\Omega$	
				–	1.7	13.5	$\Omega$	
Drain–Source ON–Voltage NTE491	$V_{DS(\text{on})}$	$V_{GS} = 10\text{V}, I_D = 500\text{mA}$		–	0.6	2.5	V	
		$V_{GS} = 4.5\text{V}, I_D = 75\text{mA}$		–	0.14	0.45	V	
		$V_{GS} = 10\text{V}, I_D = 500\text{mA}$		–	0.6	3.75	V	
		$V_{GS} = 4.5\text{V}, I_D = 75\text{mA}$		–	0.9	1.5	V	
ON–State Drain Current NTE491	$I_{d(\text{on})}$	$V_{GS} = 4.5\text{V}, V_{DS} = 10\text{V}$		75	600	–	mA	
		$V_{GS} = 10\text{V}, V_{DS} \geq 2 V_{DS(\text{on})}$		500	2700	–	mA	
Forward Transconductance NTE491	$g_{fs}$	$V_{DS} = 10\text{V}, I_D = 200\text{mA}$		100	320	–	$\mu\text{mhos}$	
		$V_{DS} \geq 2 V_{DS(\text{on})}, I_D = 200\text{mA}$		80	320	–	$\mu\text{mhos}$	
<b>Dynamic Characteristics</b>								
Input Capacitance	$C_{iss}$	$V_{DS} = 25\text{V}, V_{GS} = 0, f = 1\text{MHz}$		–	20	50	pF	
Reverse Transfer Capacitance	$C_{oss}$			–	11	25	pF	
Output Capacitance	$C_{rss}$			–	4	5	pF	

Note 1. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

**Electrical Characteristics (Cont'd):** ( $T_A = +25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Turn-On Time NTE491	$t_{on}$	$V_{DD} = 15\text{V}$ , $R_L = 25\Omega$ , $I_D = 500\text{mA}$ , $V_{GS} = 10\text{V}$ , $R_{GEN} = 25\Omega$	-	-	10	ns
NTE491SM		$V_{DD} = 30\text{V}$ , $R_L = 150\Omega$ , $I_D = 200\text{mA}$ , $V_{GS} = 10\text{V}$ , $R_{GEN} = 25\Omega$	-	-	20	ns
Turn-Off Time NTE491	$t_{off}$	$V_{DD} = 15\text{V}$ , $R_L = 25\Omega$ , $I_D = 500\text{mA}$ , $V_{GS} = 10\text{V}$ , $R_{GEN} = 25\Omega$	-	-	10	ns
NTE491SM		$V_{DD} = 30\text{V}$ , $R_L = 150\Omega$ , $I_D = 200\text{mA}$ , $V_{GS} = 10\text{V}$ , $R_{GEN} = 25\Omega$	-	-	20	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings (NTE491SM ONLY)</b>						
Maximum Continuous Drain-Source Diode Forward Current	$I_S$		-	-	115	mA
Maximum Pulsed Drain-Source Diode Forward Current	$I_{SM}$		-	-	0.8	A
Drain-Source Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0$ , $I_S = 115\text{mA}$ , Note 1	-	0.88	1.5	V

Note 1. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

